ALPHA & OMEGA SEMICONDUCTOR

AON6810

AlphaMOS 30V Common Drain N-Channel

General Description

- Latest Trench Power AlphaMOS (αMOS LV) technology
- Very Low $R_{DS(ON)}$ at 4.5V V_{GS}
- Low Gate Charge
- ESD protection
- RoHS and Halogen-Free Compliant
- Common Drain
- Integrated Temp Sense Diode

Application

- Battery Management

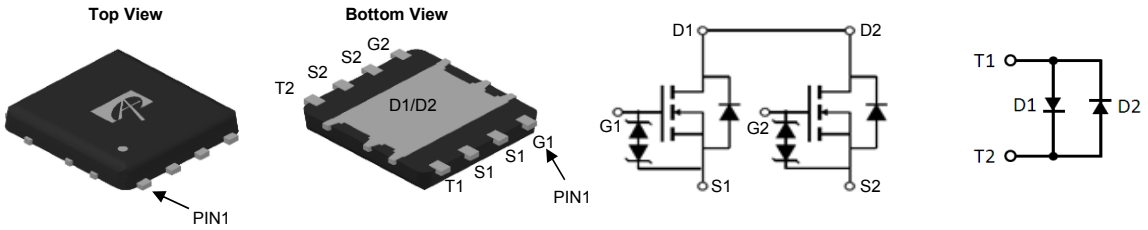
Product Summary

V_{DS}	30V
I_D (at V_{GS}=10V)	20A
$R_{DS(ON)}$ (at V_{GS}=10V)	< 4.4mΩ
$R_{DS(ON)}$ (at V_{GS}=4.5V)	< 6.5mΩ
Typical ESD protection	**HBM Class 3A**

100% UIS Tested
100% R_g Tested

Green Product

DFN5X6B



Absolute Maximum Ratings T_A=25°C unless otherwise noted

Parameter		Symbol	Maximum	Units
Drain-Source Voltage		V_{DS}	30	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current [G]	T_C=25°C	I_D	20	A
	T_C=100°C		20	
Pulsed Drain Current [C]		I_{DM}	80	
Continuous Drain Current [G]	T_A=25°C	I_{DSM}	20	A
	T_A=70°C		20	
Avalanche Current [C]		I_{AS}	40	A
Avalanche energy L=0.05mH [C]		E_{AS}	40	mJ
V_{DS} Spike	100ns	V_{SPIKE}	36	V
Power Dissipation [B]	T_C=25°C	P_D	31	W
	T_C=100°C		12.5	
Power Dissipation [A]	T_A=25°C	P_{DSM}	4.1	W
	T_A=70°C		2.6	
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	°C

Thermal Characteristics

Parameter		Symbol	Typ	Max	Units
Maximum Junction-to-Ambient [A]	t ≤ 10s	$R_{\theta JA}$	24	30	°C/W
Maximum Junction-to-Ambient [A D]	Steady-State		53	64	°C/W
Maximum Junction-to-Case	Steady-State	$R_{\theta JC}$	3	4	°C/W

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	ID=250µA, V_{GS}=0V	30			V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=30V, V_{GS}=0V			1	µA
		T_J=125°C			5	
I_{GSS}	Gate-Body leakage current	V_{DS}=0V, V_{GS}=±16V			±10	µA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=250µA	1.4	1.8	2.2	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS}=10V, I_D=20A		3.6	4.4	mΩ
		T_J=125°C		4.8	5.8	
		V_{GS}=4.5V, I_D=20A		5.2	6.5	mΩ
g_{FS}	Forward Transconductance	V_{DS}=5V, I_D=20A		83		S
V_{SD}	Diode Forward Voltage	I_S=1A,V_{GS}=0V		0.68	1	V
V_{FD1}	Sense Diode Forward Voltage	I_F=50µA		0.72	0.78	V
V_{FD2}		I_F=50µA		0.72	0.78	
I_S	Maximum Body-Diode Continuous Current [G]				20	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	V_{GS}=0V, V_{DS}=15V, f=1MHz		1720		pF
C_{oss}	Output Capacitance			746		pF
C_{rss}	Reverse Transfer Capacitance			61		pF
R_g	Gate resistance	V_{GS}=0V, V_{DS}=0V, f=1MHz	2.6	5.2	7.8	Ω
SWITCHING PARAMETERS						
Q_g(10V)	Total Gate Charge	V_{GS}=10V, V_{DS}=15V, I_D=20A		24	34	nC
Q_g(4.5V)	Total Gate Charge			11	20	nC
Q_{gs}	Gate Source Charge			5.9		nC
Q_{gd}	Gate Drain Charge			3.2		nC
$t_{D(on)}$	Turn-On DelayTime	V_{GS}=10V, V_{DS}=15V, R_L=0.75Ω, R_{GEN}=3Ω		5.8		ns
t_r	Turn-On Rise Time			3.5		ns
$t_{D(off)}$	Turn-Off DelayTime			57.5		ns
t_f	Turn-Off Fall Time			70		ns
t_{rr}	Body Diode Reverse Recovery Time	I_F=20A, dI/dt=500A/µs		20		ns
Q_{rr}	Body Diode Reverse Recovery Charge	I_F=20A, dI/dt=500A/µs		30		nC

A. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25° C. The Power dissipation P_{DSM} is based on $R_{\theta JA}$ t≤ 10s and the maximum allowed junction temperature of 150° C. The value in any given application depends on the user's specific board design.
B. The power dissipation P_D is based on $T_{J(MAX)}$=150° C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
C. Single pulse width limited by junction temperature $T_{J(MAX)}$=150° C.
D. The $R_{\theta JA}$ is the sum of the thermal impedance from junction to case $R_{\theta JC}$ and case to ambient.
E. The static characteristics in Figures 1 to 6 are obtained using <300µs pulses, duty cycle 0.5% max.
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{J(MAX)}$=150° C. The SOA curve provides a single pulse rating.
G. The maximum current rating is package limited.
H. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25° C.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

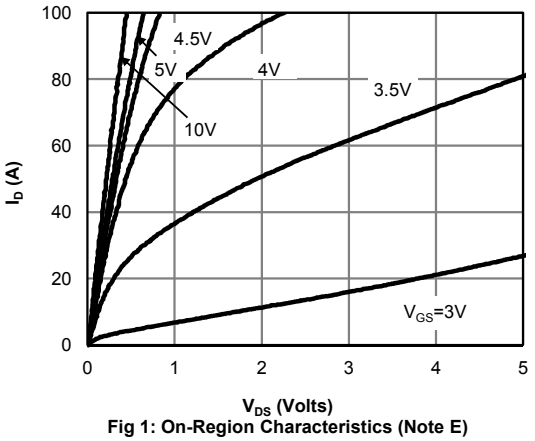


Fig 1: On-Region Characteristics (Note E)

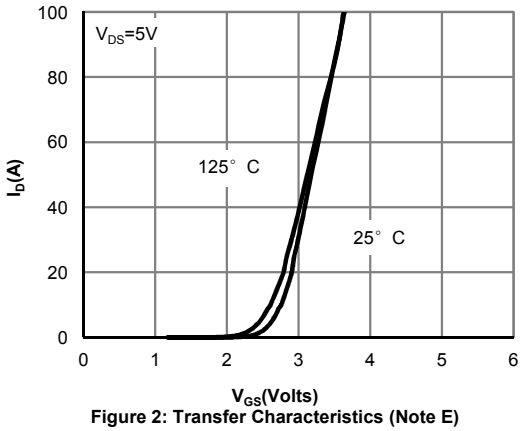


Figure 2: Transfer Characteristics (Note E)

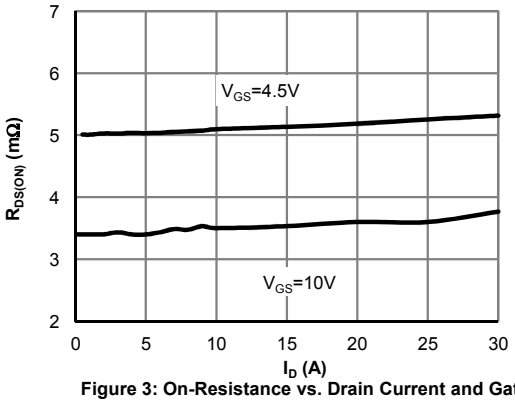


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

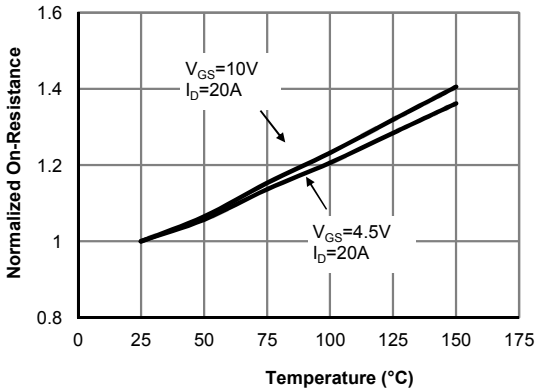


Figure 4: On-Resistance vs. Junction Temperature (Note E)

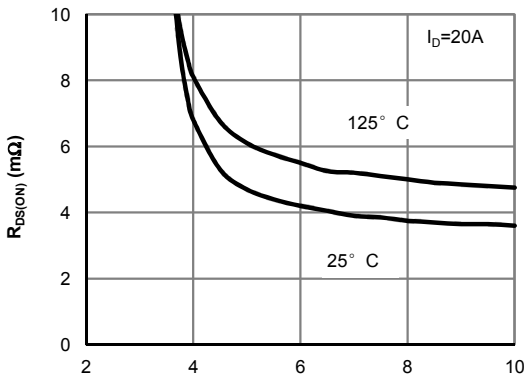


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

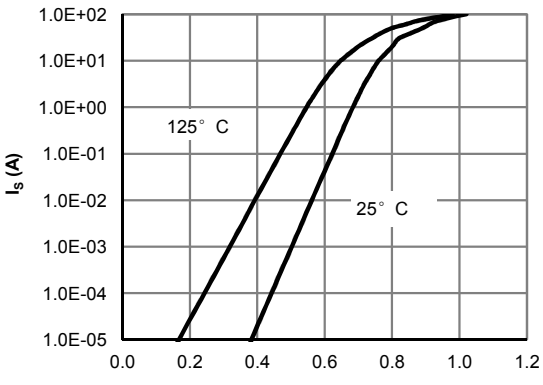


Figure 6: Body-Diode Characteristics (Note E)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

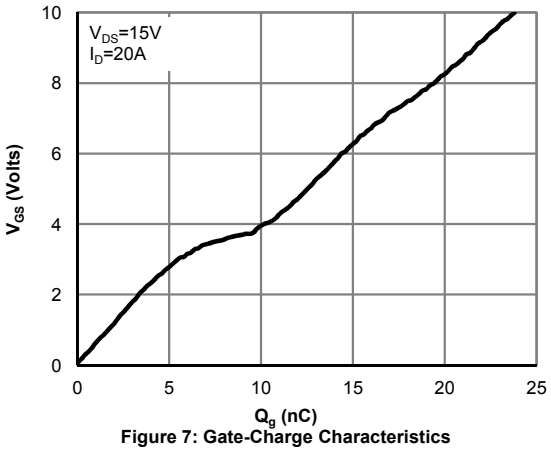


Figure 7: Gate-Charge Characteristics

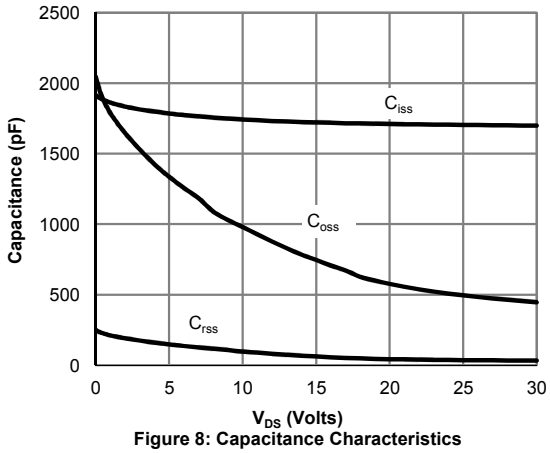


Figure 8: Capacitance Characteristics

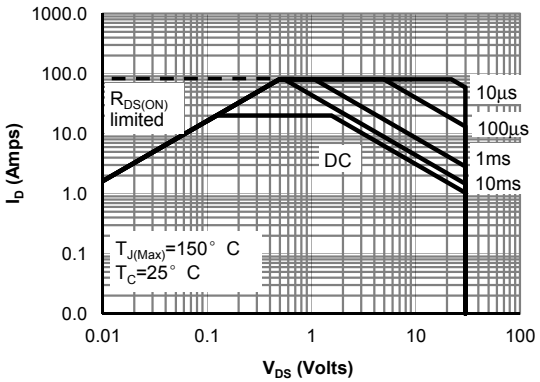


Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

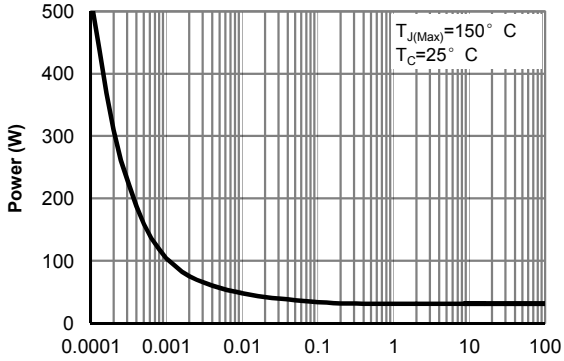


Figure 10: Single Pulse Power Rating Junction-to-Case (Note F)

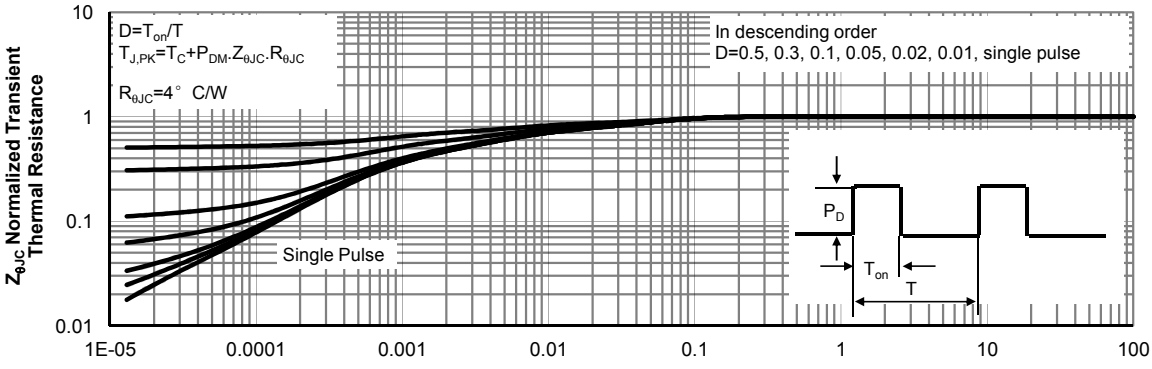


Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

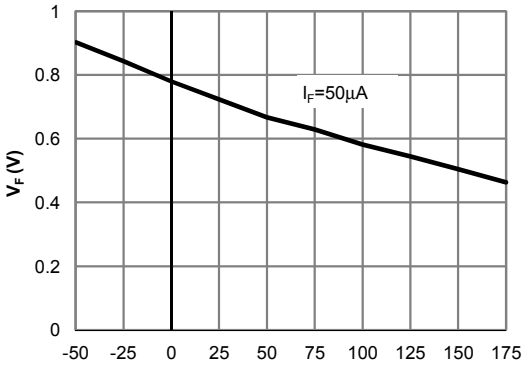


Figure 12: Sense Diode Forward Voltage vs. Temperature

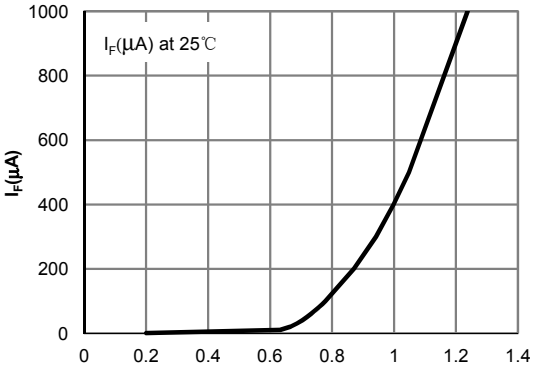


Figure 13: Sense Diode Forward Voltage

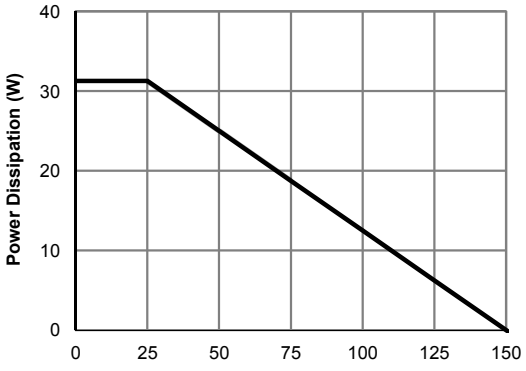


Figure 14: Power De-rating (Note F)

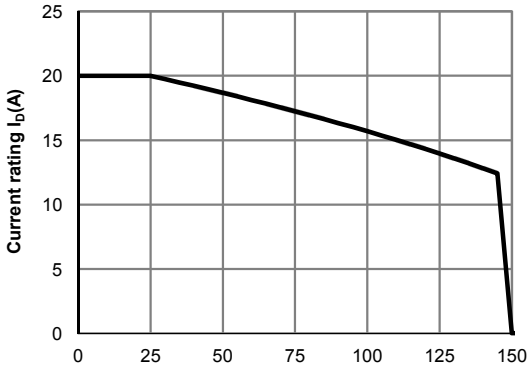


Figure 15: Current De-rating (Note F)

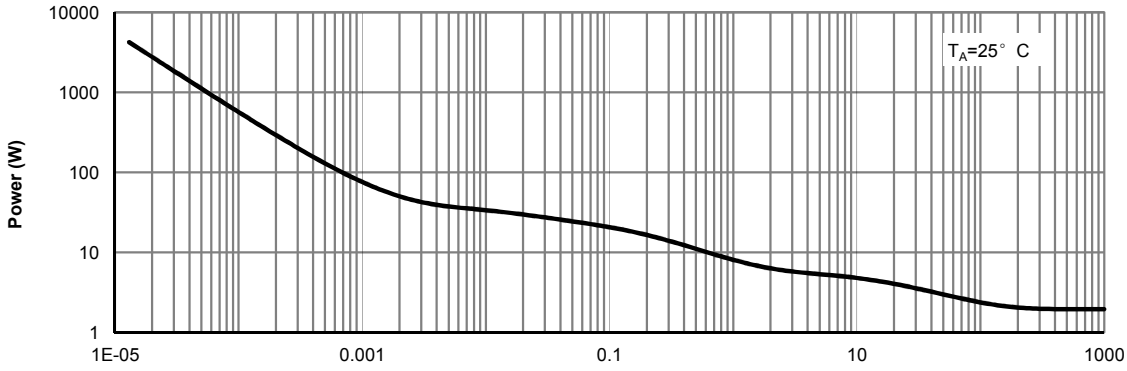


Figure 16: Single Pulse Power Rating Junction-to-Ambient (Note H)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

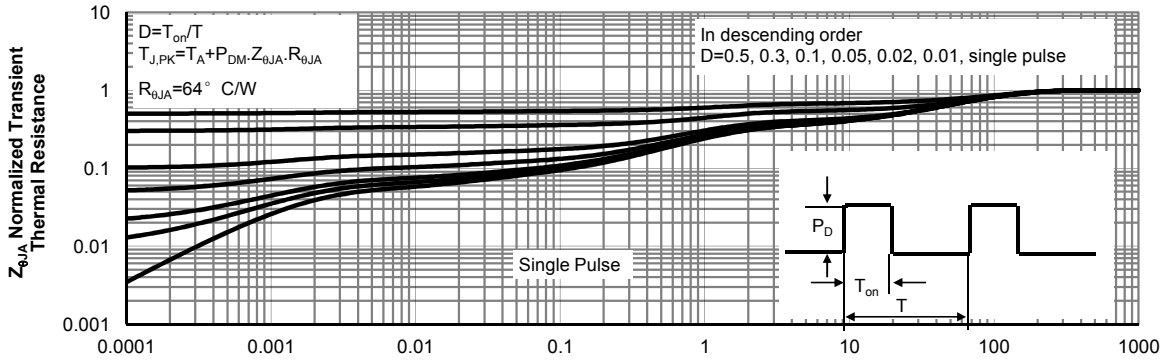
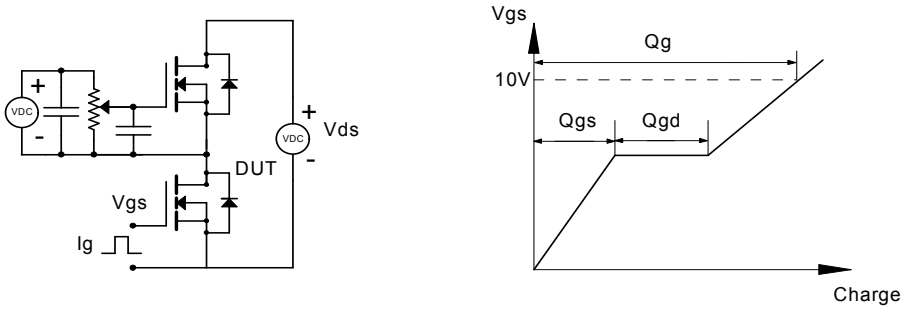
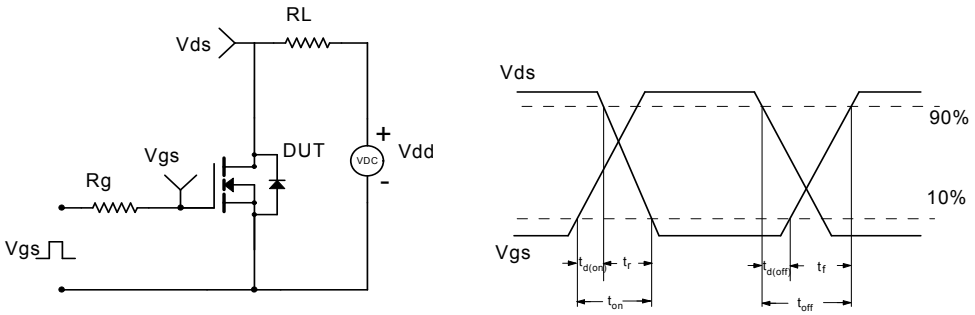


Figure 17: Normalized Maximum Transient Thermal Impedance (Note H)

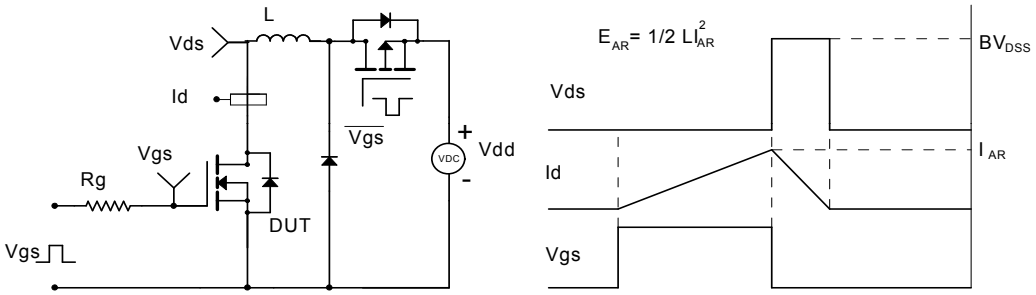
Gate Charge Test Circuit & Waveform



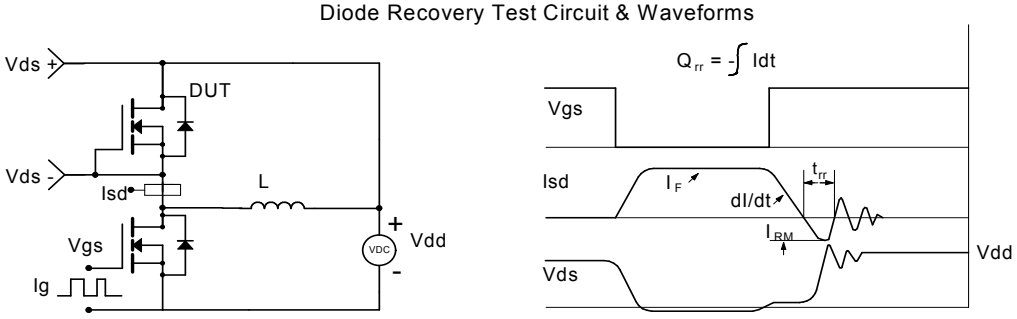
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



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